

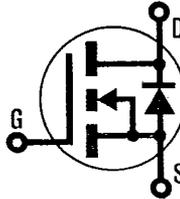
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HEXFET® TRANSISTORS IRFJ340

**N-CHANNEL
POWER MOSFETs**



- IRFJ341**
- IRFJ342**
- IRFJ343**

400 Volt, 0.55 Ohm HEXFET

The HEXFET® technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry and unique processing of the HEXFET design achieve very low on-state resistance combined with high transconductance and great device ruggedness.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling, and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, and high energy pulse circuits.

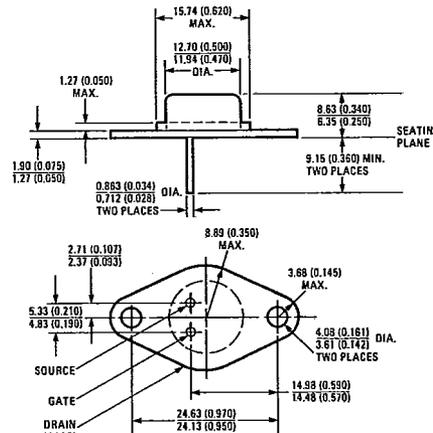
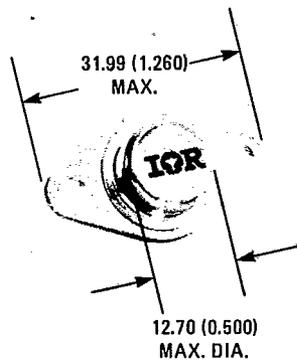
Features:

- Fast Switching
- Low Drive Current
- Ease of Paralleling
- Excellent Temperature Stability

Product Summary

| Part Number | V _{DS} | R _{DS(on)} | I _D |
|-------------|-----------------|---------------------|----------------|
| IRFJ340 | 400V | 0.55Ω | 7.5A |
| IRFJ341 | 350V | 0.55Ω | 7.5A |
| IRFJ342 | 400V | 0.80Ω | 6.0A |
| IRFJ343 | 350V | 0.80Ω | 6.0A |

CASE STYLE AND DIMENSIONS



Conforms to JEDEC Case Style TO-213AA (TO-66)
Dimensions in Millimeters and (Inches)

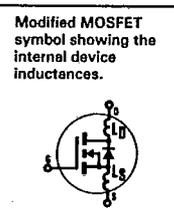
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Absolute Maximum Ratings

| Parameter | IRFJ340 | IRFJ341 | IRFJ342 | IRFJ343 | Units |
|--|---|---------|---------|---------|-------|
| V _{DS} Drain - Source Voltage ① | 400 | 350 | 400 | 350 | V |
| V _{DGR} Drain - Gate Voltage (R _{GS} = 20kΩ) ① | 400 | 350 | 400 | 350 | V |
| I _D @ T _C = 25°C Continuous Drain Current | 7.5 | 7.5 | 6.0 | 6.0 | A |
| I _D @ T _C = 100°C Continuous Drain Current | 5.0 | 5.0 | 4.0 | 4.0 | A |
| I _{DM} Pulsed Drain Current ③ | 30 | 30 | 25 | 25 | A |
| V _{GS} Gate - Source Voltage | ± 20 | | | | V |
| P _D @ T _C = 25°C Max. Power Dissipation | 70 (See Fig. 14) | | | | W |
| Linear Derating Factor | 0.55 (See Fig. 14) | | | | W/K ④ |
| I _{LM} Inductive Current, Clamped | (See Fig. 15 and 16) L = 100μH | | | | A |
| T _J Operating Junction and Storage Temperature Range | -55 to 150 | | | | °C |
| T _{stg} Lead Temperature | 300 (0.063 in. (1.6mm) from case for 10s) | | | | °C |

Electrical Characteristics @ T_C = 25°C (Unless Otherwise Specified)

| Parameter | Type | Min. | Typ. | Max. | Units | Test Conditions |
|--|--------------------|------|------|------|-------|--|
| BV _{DSS} Drain - Source Breakdown Voltage | IRFJ340 | 400 | - | - | V | V _{GS} = 0V I _D = 250μA |
| | IRFJ342 | 400 | - | - | V | |
| | IRFJ341 IRFJ343 | 350 | - | - | V | |
| V _{GS(th)} Gate Threshold Voltage | ALL | 2.0 | - | 4.0 | V | V _{DS} = V _{GS} , I _D = 250μA |
| I _{GSS} Gate - Source Leakage Forward | ALL | - | - | 100 | nA | V _{GS} = 20V |
| I _{GSS} Gate - Source Leakage Reverse | ALL | - | - | -100 | nA | V _{GS} = -20V |
| I _{DSS} Zero Gate Voltage Drain Current | ALL | - | - | 250 | μA | V _{DS} = Max. Rating, V _{GS} = 0V |
| | | - | - | 1000 | μA | V _{DS} = Max. Rating x 0.8, V _{GS} = 0V, T _C = 125°C |
| I _{D(on)} On-State Drain Current ② | IRFJ340 | 7.5 | - | - | A | V _{DS} > I _{D(on)} × R _{DSON(max)} , V _{GS} = 10V |
| | IRFJ341 | 7.5 | - | - | A | |
| | IRFJ342 IRFJ343 | 6.0 | - | - | A | |
| R _{DSON} Static Drain-Source On-State Resistance ② | IRFJ340 | - | 0.47 | 0.55 | Ω | V _{GS} = 10V, I _D = 6.2A |
| | IRFJ341 | - | 0.47 | 0.55 | Ω | |
| | IRFJ342 IRFJ343 | - | 0.68 | 0.80 | Ω | |
| g _{fs} Forward Transconductance ② | ALL | 4.0 | 7.5 | - | S (Ω) | V _{DS} > I _{D(on)} × R _{DSON(max)} , I _D = 6.2A |
| C _{iss} Input Capacitance | ALL | - | 1250 | 1600 | pF | V _{GS} = 0V, V _{DS} = 25V, f = 1.0 MHz See Fig. 10 |
| C _{oss} Output Capacitance | ALL | - | 300 | 450 | pF | |
| C _{rss} Reverse Transfer Capacitance | ALL | - | 80 | 150 | pF | |
| t _{d(on)} Turn-On Delay Time | ALL | - | 17 | 35 | ns | V _{DD} = 175V, I _D = 6.2A, Z _o = 4.7Ω See Fig. 17 (MOSFET switching times are essentially independent of operating temperature.) |
| t _r Rise Time | ALL | - | 5.0 | 15 | ns | |
| t _{d(off)} Turn-Off Delay Time | ALL | - | 45 | 90 | ns | |
| t _f Fall Time | ALL | - | 16 | 35 | ns | |
| Q _g Total Gate Charge (Gate-Source Plus Gate-Drain) | ALL | - | 41 | 60 | nC | |
| Q _{gs} Gate-Source Charge | ALL | - | 18 | - | nC | V _{GS} = 10V, I _D = 9.5A, V _{DS} = 0.8 Max. Rating. See Fig. 18 for test circuit. (Gate charge is essentially independent of operating temperature.) |
| Q _{gd} Gate-Drain ("Miller") Charge | ALL | - | 23 | - | nC | |
| L _D Internal Drain Inductance | ALL | - | 5.0 | - | nH | |
| L _S Internal Source Inductance | ALL | - | 12.5 | - | nH | Measured from the source pin, 6 mm (0.25 in.) from header and source bonding pad. |



Thermal Resistance

| Parameter | ALL | Min. | Typ. | Max. | Units | Notes |
|---------------------------------------|-----|------|------|------|-------|---|
| R _{thJC} Junction-to-Case | ALL | - | - | 1.8 | K/W ④ | |
| R _{thCS} Case-to-Sink | ALL | - | 0.2 | - | K/W ④ | Mounting surface flat, smooth, and greased. |
| R _{thJA} Junction-to-Ambient | ALL | - | - | 50 | K/W ④ | Typical socket mount |

Source-Drain Diode Ratings and Characteristics

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| | | | | | | | |
|----------|--|---------|--|-----|-----|---------------|---|
| I_S | Continuous Source Current (Body Diode) | IRFJ340 | — | — | 7.5 | A | Modified MOSFET symbol showing the integral reverse P-N junction rectifier. |
| | | IRFJ341 | — | — | 6.0 | A | |
| I_{SM} | Pulse Source Current (Body Diode) ③ | IRFJ340 | — | — | 30 | A | |
| | | IRFJ341 | — | — | 25 | A | |
| V_{SD} | Diode Forward Voltage ② | IRFJ340 | — | — | 2.0 | V | $T_C = 25^\circ\text{C}, I_S = 7.5, V_{GS} = 0\text{V}$ |
| | | IRFJ341 | — | — | 1.9 | V | |
| t_{rr} | Reverse Recovery Time | ALL | — | 800 | — | ns | $T_J = 150^\circ\text{C}, I_F = 7.5\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$ |
| Q_{RR} | Reverse Recovered Charge | ALL | — | 5.7 | — | μC | $T_J = 150^\circ\text{C}, I_F = 7.5\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$ |
| t_{on} | Forward Turn-on Time | ALL | Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_S + L_D$. | | | | |



- ① $T_J = 25^\circ\text{C}$ to 150°C .
- ② Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
- ③ Repetitive Rating: Pulse width limited by max. junction temperature. See Transient Thermal Impedance Curve (Fig. 5).
- ④ $\text{KW} = \text{ }^\circ\text{CAW}$
 $\text{WK} = \text{W}/^\circ\text{C}$

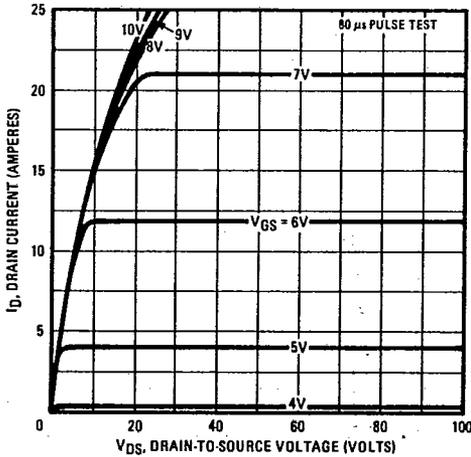


Fig. 1 - Typical Output Characteristics

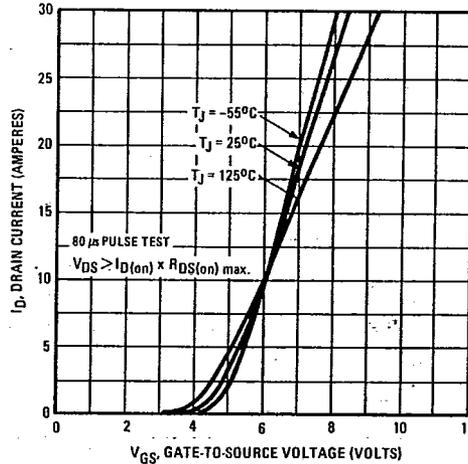


Fig. 2 - Typical Transfer Characteristics

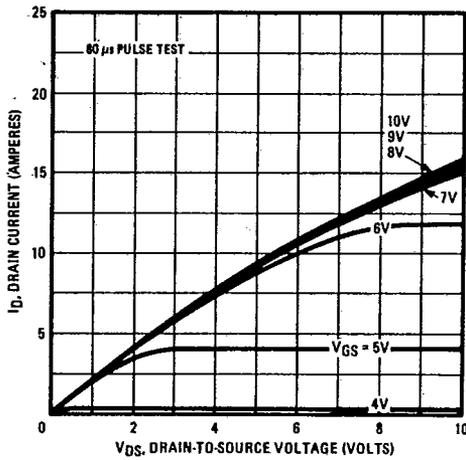


Fig. 3 - Typical Saturation Characteristics

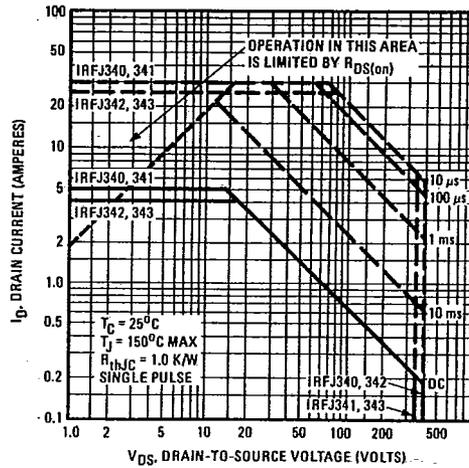


Fig. 4 - Maximum Safe Operating Area

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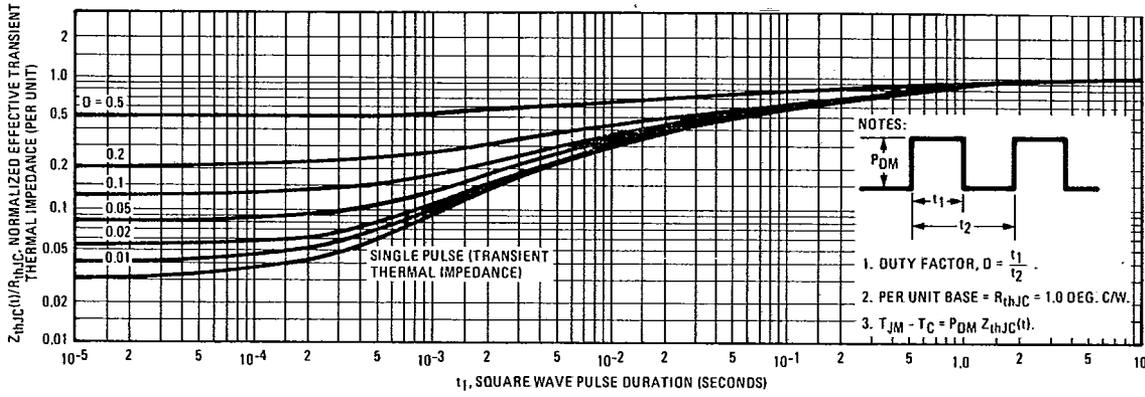


Fig. 5 – Maximum Effective Transient Thermal Impedance, Junction-to-Case Vs. Pulse Duration

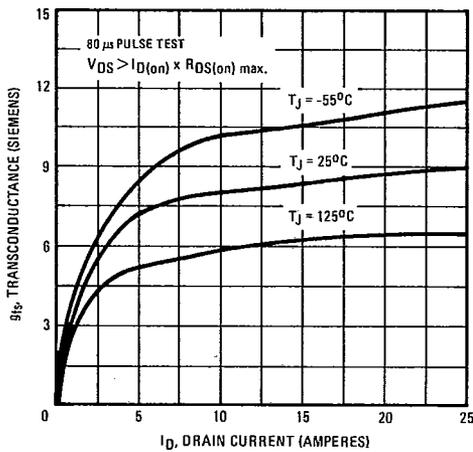


Fig. 6 – Typical Transconductance Vs. Drain Current

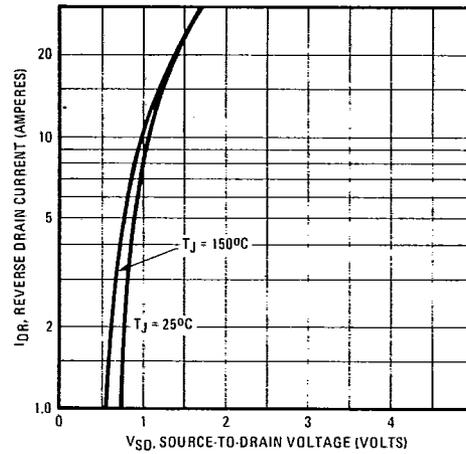


Fig. 7 – Typical Source-Drain Diode Forward Voltage

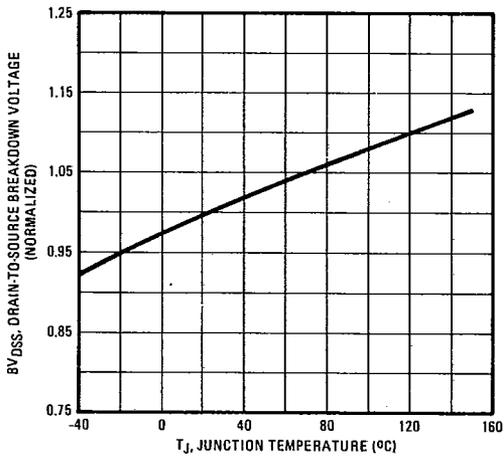


Fig. 8 – Breakdown Voltage Vs. Temperature

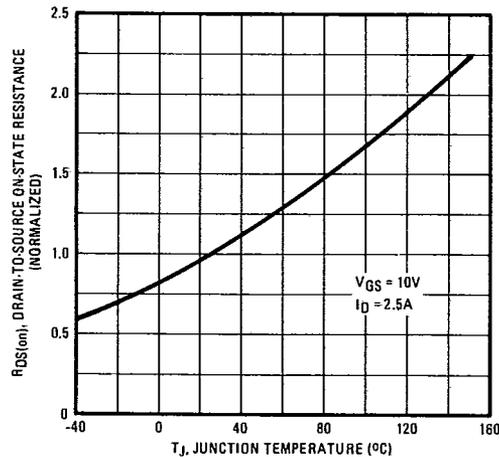


Fig. 9 – Normalized On-Resistance Vs. Temperature

IRFJ340, IRFJ341, IRFJ342, IRFJ343 Devices

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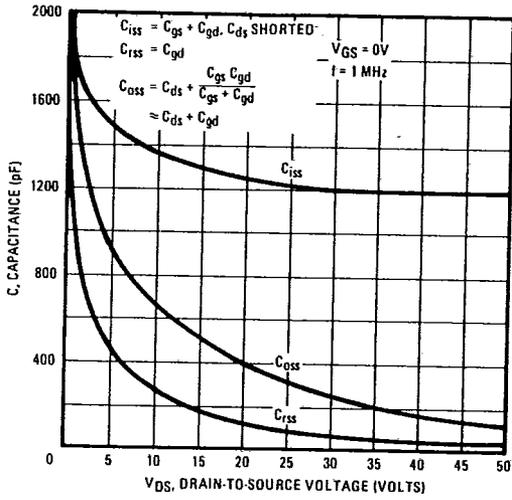


Fig. 10 - Typical Capacitance Vs. Drain-to-Source Voltage

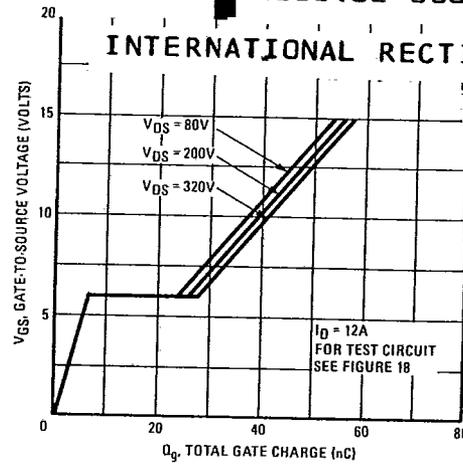


Fig. 11 - Typical Gate Charge Vs. Gate-to-Source Voltage

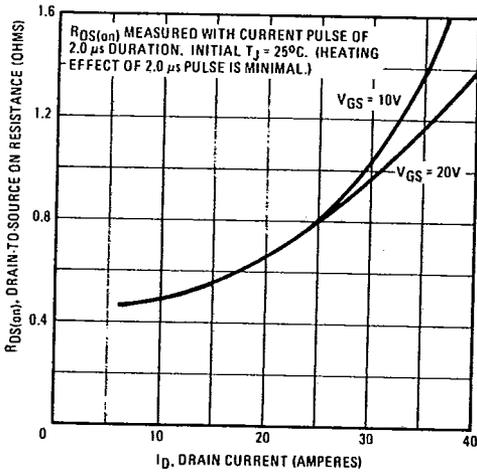


Fig. 12 - Typical On-Resistance Vs. Drain Current

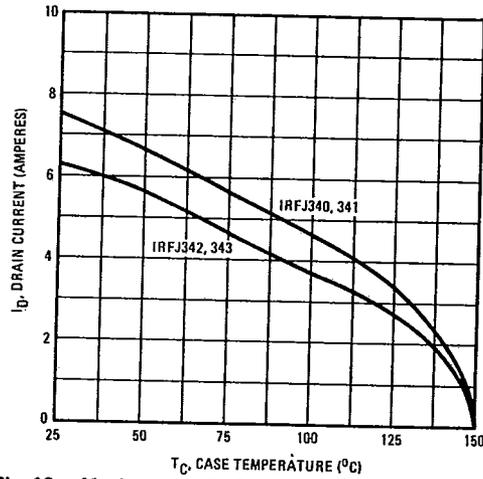


Fig. 13 - Maximum Drain Current Vs. Case Temperature

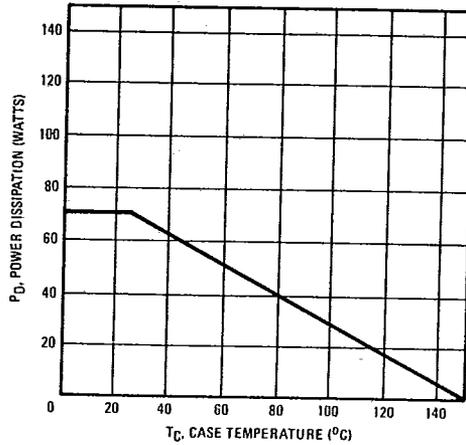


Fig. 14 - Power Vs. Temperature Derating Curve

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IRFJ340, IRFJ341, IRFJ342, IRFJ343 Devices

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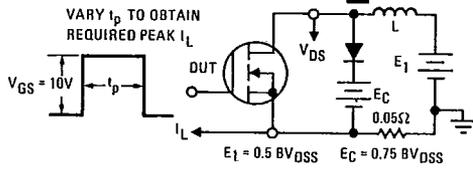


Fig. 15 - Clamped Inductive Test Circuit

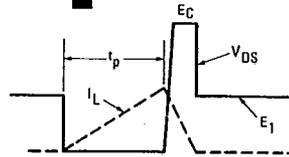


Fig. 16 - Clamped Inductive Waveforms

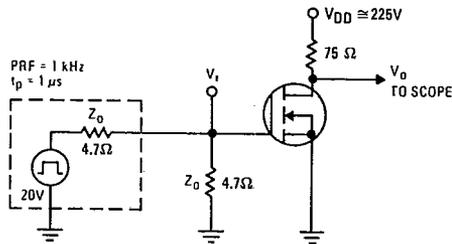


Fig. 17 - Switching Time Test Circuit

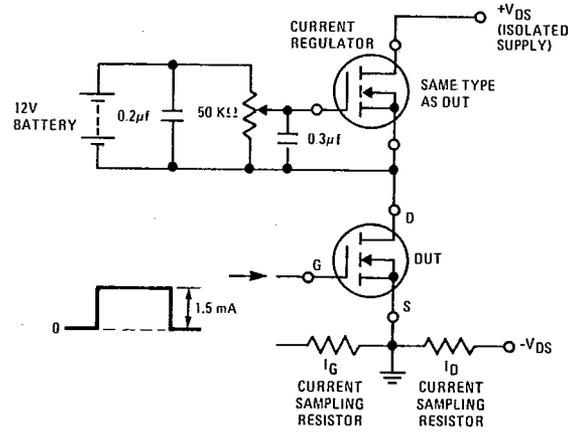


Fig. 18 - Gate Charge Test Circuit